

## FEATURES

- High reliability LPE GaAIAs IRLEDs
- Ultra high power output
- 880nm peak emission
- Six chips connected in series
- Very wide angle of emission
- Electrically isolated case

All surfaces are gold plated. Dimensions are nominal values in inches unless otherwise specified.



## ELECTRO-OPTICAL CHARACTERISTICS AT 25°C

PARAMETERS	TEST CONDITIONS	MIN	TYP	MAX	UNITS
Total Power Output, $P_o$	$I_F = 300\text{mA}$ $I_F = 6\text{A}$	300	330 5000		mW
Peak Emission Wavelength, $\lambda_p$	$I_F = 50\text{mA}$		880		nm
Spectral Bandwidth at 50%, $\Delta\lambda$			80		nm
Half Intensity Beam Angle, $\theta$				120	
Forward Voltage, $V_F$	$I_F = 300\text{mA}$		9	10	Volts
Reverse Breakdown Voltage, $V_R$	$I_R = 10\mu\text{A}$	5	30		Volts
Capacitance, C	$V_R = 0\text{V}$		15		pF
Rise Time			2		$\mu\text{sec}$
Fall Time			2		$\mu\text{sec}$

## ABSOLUTE MAXIMUM RATINGS AT 25°C CASE

Power Dissipation <sup>1</sup>	4W
Continuous Forward Current	400mA
Peak Forward Current (10 $\mu\text{s}$ , 400Hz) <sup>2</sup>	6A
Reverse Voltage	5V
Lead Soldering Temperature (1/16" from case for 10sec)	260°C

<sup>1</sup>Derate per Thermal Derating Curve above 25°C

<sup>2</sup>Derate linearly above 25°C

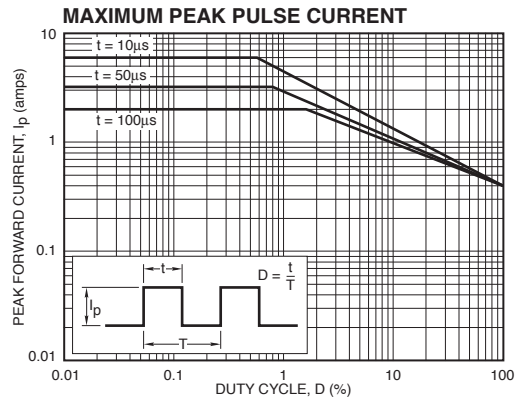
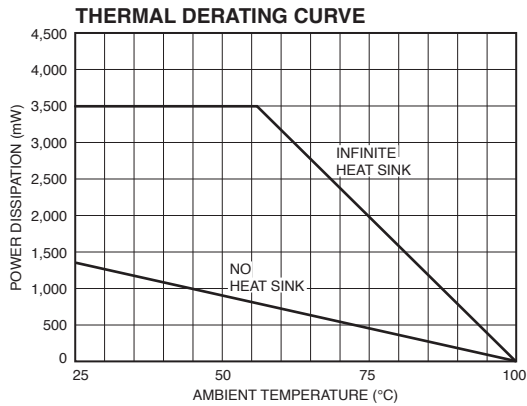
## THERMAL PARAMETERS

Storage and Operating Temperature Range	-55°C to 100°C
Maximum Junction Temperature	100°C
Thermal Resistance, $R_{THJA}$ <sup>1</sup>	60°C/W Typical
Thermal Resistance, $R_{THJA}$ <sup>2</sup>	16°C/W Typical

<sup>1</sup>Heat transfer minimized by measuring in still air with minimum heat conducting through leads

<sup>2</sup>Air circulating at a rapid rate to keep case temperature at 25°C

MAXIMUM RATINGS



TYPICAL CHARACTERISTICS

